# DATA SHEET

### **CBT6832**

16-bit 1-of-2 multiplexer/demultiplexer with precharged outputs and Schottky undershoot protection for live insertion

**Product specification** 





## 16-bit 1-of-2 multiplexer/demultiplexer with precharged outputs and Schottky undershoot protection for live insertion

**CBT6832** 

#### **FEATURES**

- 5 Ω typical r<sub>on</sub>
- Pull-up on B ports
- Undershoot protection on A port only: -1.5 V
- Near zero propagation delay
- Controlled enable rate
- V<sub>CC</sub> operating range: +4.5 V to +5.5 V
- > 100 MHz bandwidth (or clock rate) at 20 pF load capacitance
- 56-pin TSSOP package
- Bias voltage pre-charges the B output when the channel is disabled
- Latch-up protection exceeds 100 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114,
   200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

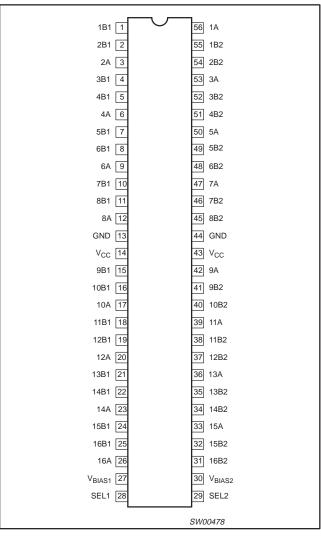
#### **APPLICATION**

Provides PCI hot-plugging

#### **DESCRIPTION**

The CBT6832 is a 16-bit 1-of-2 multiplexer/demultiplexer with precharged outputs and Schottky protection for live insertion. Advantages of the CBT6832 include a propagation delay of 250 ps, resulting from 5  $\Omega$  channel resistance, and low I/O capacitance. A port demultiplexes to either 1B and 2B, or to both. The switch is bi-directional.

#### **PIN CONFIGURATION**



#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25°C; GND = 0 V	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	$C_L = 50 \text{ pF}; V_{CC} = 5 \text{ V}$	0.25	ns
C <sub>IN</sub>	Input capacitance	$V_I = 0 \text{ V or } V_{CC}$	4.5	pF
C <sub>OUT</sub> B	B capacitance	Outputs disabled; V <sub>O</sub> = 0 V	8	pF
C <sub>OUT</sub> A	A capacitance	Outputs disabled; V <sub>O</sub> = 0 V	13	pF
C on 1	One channel on capacitance	One B enabled; V <sub>O</sub> = 0 V	21	pF
C on 2	Both channels on capacitance	Both B channels enabled; V <sub>O</sub> = 0 V	34	pF

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
56-Pin Plastic TSSOP Type II	0°C to +70°C	CBT6832 DGG	SOT364-1

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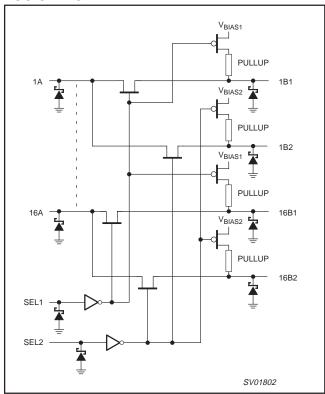
#### PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
3, 6, 9, 12, 17, 20, 23, 26, 33, 36, 39, 42, 47, 50, 53, 56	1A1–16A1	Inputs
1, 2, 4, 5, 7, 8, 10, 11, 15, 16, 18, 19, 21, 22, 24, 25	1B1–16B1	Outputs
31, 32, 34, 35, 37, 38, 40, 41, 45, 46, 48, 49, 51, 52, 54, 55	1B2–16B2	Outputs
27, 30	V <sub>BIAS1</sub> , V <sub>BIAS2</sub>	Precharge bias voltage inputs
28, 29	SEL1, SEL2	Select-control inputs
13, 44	GND	Ground (0 V)
14, 43	V <sub>CC</sub>	Positive supply voltage

#### **FUNCTION TABLE**

SEL1	SEL2	FUNCTION
L	Н	nA to nB1
Н	L	nA to nB2
L	L	nA to nB1 and nB2
Н	Н	nB1, nB2 = V <sub>BIAS</sub>

#### **LOGIC DIAGRAM**



#### ABSOLUTE MAXIMUM RATINGS1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < 0	<b>–</b> 50	mA
VI	DC input voltage <sup>3</sup>		−0.5 to +7.0	V
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	output in Off or High state	-0.5 to +7.0	V
I <sub>OUT</sub>	DC output current	output in Low state	120	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
$\Theta_{JA}$	Power dissipation		95	°C/W

#### NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
  device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
  absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIM	LINUT	
STWIBUL	PARAMETER	MIN	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	4.5	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0		V
V <sub>IL</sub>	Low-level Input voltage		0.8	V
T <sub>amb</sub>	Operating free-air temperature range	0	+70	°C

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#### DC ELECTRICAL CHARACTERISTICS

Over operating temperature range  $T_{amb} = 0^{\circ}C$  to  $+70^{\circ}C$ ;  $V_{CC} = 5$  V  $\pm 10\%$ ;  $V_{BIAS} = 1.3$  V to  $V_{CC}$ , unless otherwise specified.

OVMDOL	DADAMETER	TEGT COMPITIONS				
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>1</sup>	MAX	UNIT
V <sub>IH</sub>	Input HIGH voltage	Guaranteed logic HIGH level	2.0			V
V <sub>IL</sub>	Input LOW voltage	Guaranteed logic LOW level	-0.5		0.8	V
I <sub>IH</sub>	Input HIGH current	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = V <sub>CC</sub>			±5	μА
I <sub>IL</sub>	Input LOW current	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = GND			±5	μА
I <sub>OZH</sub>	High impedance output current	$A = 0 \text{ V or } V_{CC} \text{ MAX},$ $V_{BIAS1} = V_{BIAS2} = V_{CC} \text{ MAX}$			±1	μА
I <sub>OZL</sub>	Low impedance output current	$B = 0 \text{ V or } V_{CC} \text{ MAX},$ $V_{BIAS1} = V_{BIAS2} = V_{CC} \text{ MAX}$	-0.2		-2	mA
V <sub>IK</sub>	Input clamp voltage	$V_{CC} = 4.5 \text{ V}; I_{I} = -18 \text{ mA}$			-1.2	V
_	Switch on resistance <sup>2</sup>	$V_{CC} = 4.5 \text{ V}; V_I = 0 \text{ V}; I_I = 48 \text{ mA}$		5	8	Ω
r <sub>on</sub>	Switch on resistance-	$V_{CC} = 4.5 \text{ V}; V_I = 2.4 \text{ V}; I_I = -15 \text{ mA}$		10	15	Ω
Capacitano	ce <sup>3</sup> (T <sub>amb</sub> = +25°C; f = 1 MHz)					
C <sub>IN</sub>	Input capacitance	V <sub>I</sub> = 0 V		4.5		pF
C <sub>OFF</sub> B	B capacitance, switch off	V <sub>I</sub> = 0 V		8		pF
C <sub>OFF</sub> A	A capacitance, switch off	V <sub>I</sub> = 0 V		13		pF
C <sub>ON</sub> 1	One B channel on capacitance	V <sub>I</sub> = 0 V		21		pF
C <sub>ON</sub> 2	Both B channels on capacitance	V <sub>I</sub> = 0 V		34		pF
Power sup	ply					
I <sub>CC</sub>	Quiescent supply current	$V_{CC} = 5.5 \text{ V}; V_I = V_{CC} \text{ or GND}$			200	μА
Δl <sub>CC</sub>	Additional supply current per input pin <sup>5</sup>	V <sub>CC</sub> = 5.5 V, one input at 3.4 V, other inputs at V <sub>CC</sub> or GND			2.5	mA

#### NOTES:

- All typical values are at V<sub>CC</sub> = 5 V, T<sub>amb</sub> = +25°C ambient and maximum loading.
   Measured by the voltage drop between the A and the B terminals at the indicated current through the switch.
   On-state resistance is determined by the lowest voltage of the two (A or B) terminals.
- These parameters are determined by device characterization, but is not production tested.
- 4. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- 5. Per TTL driven input (V<sub>I</sub> = 3.4 V, control inputs only); A and B pins do not contribute to I<sub>CC</sub>.
   6. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. this parameter is not tested, but is guaranteed by design.

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#### AC CHARACTERISTICS

 $V_{CC}$  = 5.0 V ±0.5 V; GND = 0  $V_{;}$   $C_{L}$  = 50 pF,  $R_{L}$  = 500  $\Omega$ 

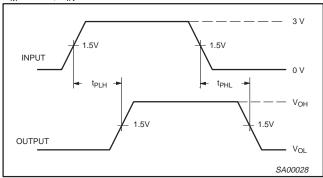
SYMBOL	PARAMETER	TEST CONDITIONS		UNIT		
STWIBUL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNII
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay <sup>1</sup> A to B			0.25		ns
t <sub>PZH</sub> t <sub>PZL</sub>	Bus enable time SEL to A, B		1 1		7.0 6.0	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Bus disable time SEL to A, B		1 1		7.0 6.5	ns

#### NOTES:

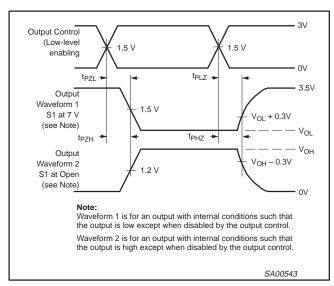
1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

#### **AC WAVEFORMS**

 $V_{M} = 1.5 \text{ V}, V_{IN} = \text{GND to } 3.0 \text{ V}$ 

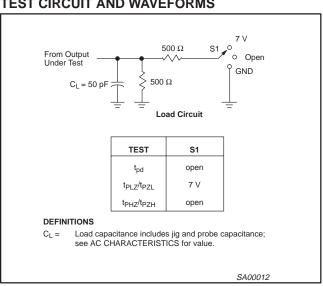


Waveform 1. Input (An) to Output (Bn) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

#### **TEST CIRCUIT AND WAVEFORMS**

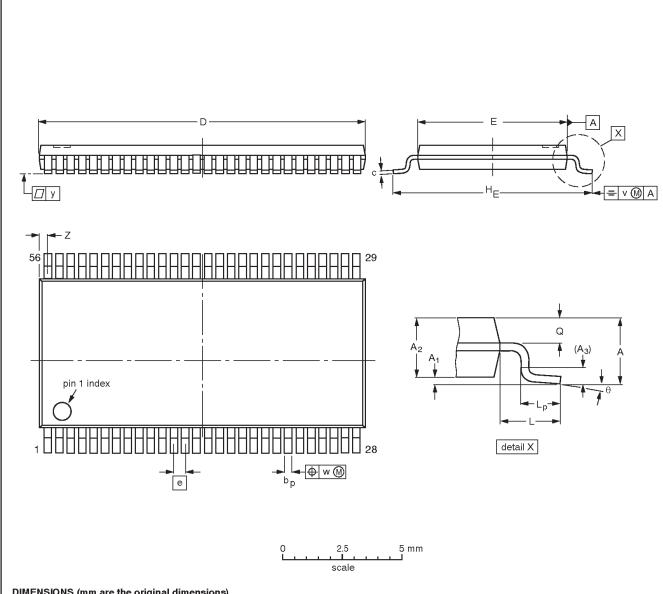


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#### TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1



#### DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT364-1		MO-153				<del>-95-02-10-</del> 99-12-27

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**NOTES** 

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#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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